



**THE DATASHEET OF
DG3540DB-T1-E1**



4 Ω , 360 MHz, Dual SPST Analog Switches

DESCRIPTION

The DG3537, DG3538, DG3539, DG3540 are dual SPST analog switches which operate from 1.8 V to 5.5 V single rail power supply. They are design for audio, video, and USB switching applications.

The devices have 4 Ω on-resistance and 360 MHz 3 dB bandwidth. 0.2 Ω on-resistance matching and 1 Ω flatness make the device high linearity. The devices are 1.6 V logic compatible within the full operation voltage range.

These switches are built on a sub-micron high density process that brings low power consumption and low voltage performance.

The switches are packaged in MICRO FOOT chip scale package of 3 x 3 bump array.

As a committed partner to the community and environment, Vishay Siliconix manufactures this product with the lead (Pb)-free device terminations. For MICRO FOOT analog switch products manufactured with tin/silver/copper (SnAgCu) device termination, the lead (Pb)-free “-E1” suffix is being used as a designator.

FEATURES

- 1.8 V to 5.5 V operation
- 3 Ω at 2.7 V R_{ON}
- 360 MHz - 3 dB bandwidth
- ESD method 3015.7 > 2 kV
- Latch-up current 0.300 mA (JESD 78)
- 1.6 V logic compatible

BENEFITS

- Space saving MICRO FOOT[®] package
- High linearity
- Low power consumption
- High bandwidth
- Full rail Signal swing range

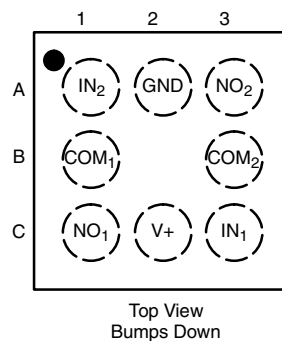
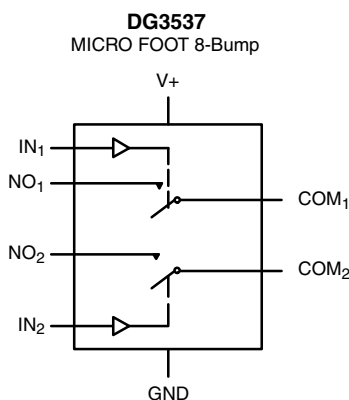
APPLICATIONS

- Cellular phones
- MP3
- Media players
- Modems
- Hard drives
- PCMCIA



RoHS
COMPLIANT

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION

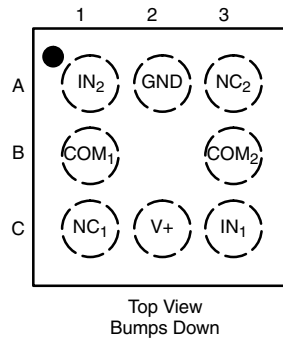
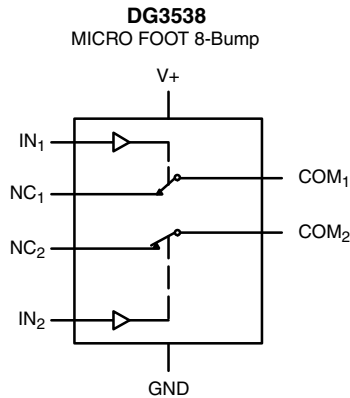


Device Marking



3537 = Device Marking
xxx = Data/Lot Traceability Code

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION

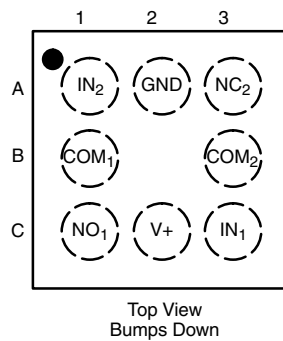
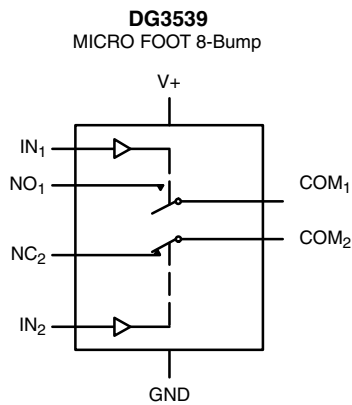


Device Marking



3538 = Device Marking

xxx = Data/Lot Traceability Code

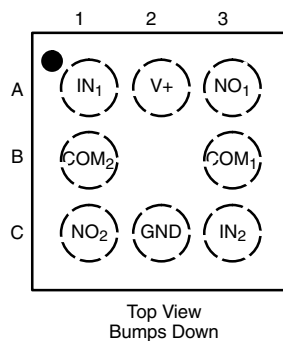
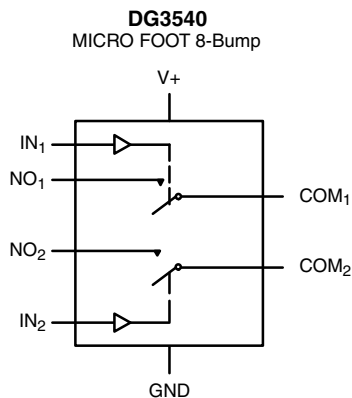


Device Marking



3539 = Device Marking

xxx = Data/Lot Traceability Code



Device Marking



3540 = Device Marking

xxx = Data/Lot Traceability Code

| TRUTH TABLE | | |
|-------------|-------------|-------------|
| Logic | NC1 and NC2 | NO1 and NO2 |
| 0 | ON | OFF |
| 1 | OFF | ON |

| ORDERING INFORMATION | | |
|----------------------|--|--|
| Temp. Range | Package | Part Number |
| - 40 °C to 85 °C | MICRO FOOT: 8 Bump (3 x 3, 0.5 mm Pitch, 238 µm Bump Height) | DG3537DB-T5-E1 DG3538DB-T5-E1 DG3539DB-T5-E1 DG3540DB-T1-E1 |



| ABSOLUTE MAXIMUM RATINGS | | | |
|--|--|-----------------------|------|
| Parameter | | Limit | Unit |
| Reference V+ to GND | | - 0.3 to + 6 | V |
| IN, COM, NC, NO ^a | | - 0.3 to (V+ + 0.3 V) | |
| Continuous Current (NO, NC, COM) | | ± 100 | mA |
| Peak Current (Pulsed at 1 ms, 10 % duty cycle) | | ± 200 | |
| Storage Temperature | (D Suffix) | - 65 to 150 | °C |
| Package Solder Reflow Conditions ^b | IR/Convection | 250 | |
| ESD per Method 3015.7 | | > 2 | kV |
| Power Dissipation (Packages) ^c | MICRO FOOT: 8 Bump (3 x 3 mm) ^d | 400 | mW |

Notes:

- a. Signals on NC, NO, or COM or IN exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- b. Refer to IPC/JEDEC (J-STD-020B)
- c. All bumps welded or soldered to PC Board.
- d. Derate 5.0 mW/°C above 70 °C.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

| SPECIFICATIONS (V+ = 3 V) | | | | | | | |
|---|---|---|--------------------|----------------------------|-------------------|-------------------|------|
| Parameter | Symbol | Test Conditions Otherwise Unless Specified V+ = 2.7 to 3.6 V, V _{IN} = 0.5 V or 1.4 V ^e | Temp. ^a | Limits - 40 °C to 85 °C | | | Unit |
| | | | | Min. ^b | Typ. ^c | Max. ^b | |
| Analog Switch | | | | | | | |
| Analog Signal Range ^d | V _{NO} , V _{NC} , V _{COM} | | Full | 0 | | V+ | V |
| On-Resistance ^d | R _{ON} | V+ = 2.7 V, V _{COM} = 0.2/1.5 V I _{NO} , I _{NC} = 10 mA | Room Full | | 3 | 4 4.3 | Ω |
| R _{ON} Flatness ^d | R _{ON} Flatness | | Room | | 0.75 | 1.2 | |
| On-Resistance Match Between Channels ^d | ΔR _{DS(on)} | | Room | | | 0.25 | |
| Switch Off Leakage Current ^f | I _{NO(off)} I _{NC(off)} | V+ = 3.6 V, V _{NO} , V _{NC} = 0.3 V/3.3 V, V _{COM} = 3.3 V/0.3 V | Room Full | - 2 - 20 | | 2 20 | nA |
| | I _{COM(off)} | | Room Full | - 2 - 20 | | 2 20 | |
| Channel-On Leakage Current ^f | I _{COM(on)} | V+ = 3.6 V, V _{NO} , V _{NC} = V _{COM} = 0.3 V/3.3 V | Room Full | - 2 - 20 | | 2 20 | |
| Digital Control | | | | | | | |
| Input High Voltage ^d | V _{INH} | | Full | 1.4 | | | V |
| Input Low Voltage | V _{INL} | | Full | | | 0.5 | |
| Input Capacitance | C _{in} | | Full | | 8 | | pF |
| Input Current ^f | I _{INL} or I _{INH} | V _{IN} = 0 or V+ | Full | 1 | | 1 | μA |

| SPECIFICATIONS (V+ = 3 V) | | | | | | | |
|-------------------------------------|-------------------------|--|--------------------|----------------------------|-------------------|-------------------|------|
| Parameter | Symbol | Test Conditions Otherwise Unless Specified V+ = 2.7 to 3.6 V, VIN = 0.5 V or 1.4 V ^e | Temp. ^a | Limits - 40 °C to 85 °C | | | Unit |
| | | | | Min. ^b | Typ. ^c | Max. ^b | |
| Dynamic Characteristics | | | | | | | |
| Turn-On Time | t _{ON} | V+ = 2.7 V, V _{NO} or V _{NC} = 1.5 V R _L = 300 Ω, C _L = 35 pF | Room Full | | 16 46 | 46 48 | ns |
| Turn-Off Time | t _{OFF} | | Room Full | | 7 37 | 37 39 | |
| Charge Injection ^d | Q _{INJ} | C _L = 1 nF, V _{GEN} = 2 V, R _{GEN} = 0 Ω | Room | | 1 | | pC |
| Off-Isolation ^d | OIRR | R _L = 50 Ω, C _L = 5 pF, f = 1 MHz | Room | | - 78.5 | | dB |
| Crosstalk ^d | X _{TALK} | | Room | | - 113 | | |
| Off-Isolation ^d | OIRR | R _L = 50 Ω, C _L = 5 pF, f = 10 MHz | Room | | - 58 | | dB |
| Crosstalk ^d | X _{TALK} | | Room | | - 66 | | |
| Off Capacitance ^d | C _{NO/NC(off)} | VIN = 0 or V+, f = 1 MHz | Room | | 8 | | pF |
| | C _{COM(off)} | | Room | | 14 | | |
| Channel-On Capacitance ^d | C _{NO/NC(on)} | | Room | | 27 | | |
| | C _{COM(on)} | | Room | | 27 | | |
| Power Supply | | | | | | | |
| Power Supply Current | I+ | V _{IN} = 0 or V+ | Room Full | | 0.001 | 1.0 1.0 | μA |

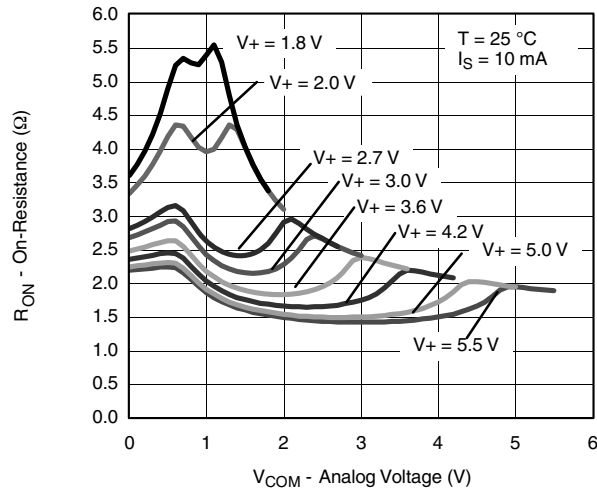


| SPECIFICATIONS (V ₊ = 5 V) | | | | | | | |
|--|---|---|--------------------|----------------------------|-------------------|-------------------|------|
| Parameter | Symbol | Test Conditions Otherwise Unless Specified V ₊ = 4.2 to 5.5 V, V _{IN} = 0.8 V or 2.0 V ^e | Temp. ^a | Limits - 40 °C to 85 °C | | | Unit |
| | | | | Min. ^b | Typ. ^c | Max. ^b | |
| Analog Switch | | | | | | | |
| Analog Signal Range ^d | V _{NO} , V _{NC} , V _{COM} | | Full | 0 | | V ₊ | V |
| On-Resistance ^d | R _{ON} | V ₊ = 4.2 V, V _{COM} = 0.5/3.5 V I _{NO} , I _{NC} = 10 mA | Room Full | | 2.6 | 3.5 3.7 | Ω |
| r _{ON} Flatness ^d | R _{ON} Flatness | | Room | | 0.8 | 1.2 | |
| On-Resistance Match Between Channels ^d | ΔR _{DS(on)} | | Room | | | 0.2 | |
| Switch Off Leakage Current | I _{NO(off)} I _{NC(off)} | V ₊ = 5.5 V, V _{NO} , V _{NC} = 1.0 V/4.5 V, V _{COM} = 4.5 V/1.0 V | Room Full | - 2 - 20 | | 2 20 | nA |
| | I _{COM(off)} | | Room Full | - 2 - 20 | | 2 20 | |
| Channel-On Leakage Current | I _{COM(on)} | V ₊ = 5.5 V, V _{NO} , V _{NC} = V _{COM} = 1.0 V/4.5 V | Room Full | - 2 - 20 | | 2 20 | |
| Digital Control | | | | | | | |
| Input High Voltage ^d | V _{INH} | | Full | 2.0 | | | V |
| Input Low Voltage | V _{INL} | | Full | | | 0.8 | |
| Input Capacitance | C _{in} | | Full | | 8 | | pF |
| Input Current | I _{INL} or I _{INH} | V _{IN} = 0 or V ₊ | Full | 1 | | 1 | μA |
| Dynamic Characteristics | | | | | | | |
| Turn-On Time | t _{ON} | V ₊ = 4.2 V, V _{NO} or V _{NC} = 3.0 V R _L = 300 Ω, C _L = 35 pF | Room Full | | 11 | 41 43 | ns |
| Turn-Off Time | t _{OFF} | | Room Full | | 7 | 37 39 | |
| Charge Injection ^d | Q _{INJ} | C _L = 1 nF, V _{GEN} = 2 V, R _{GEN} = 0 Ω | Room | | 1 | | pC |
| Off Capacitance ^d | C _{NO/NC(off)} | V _{IN} = 0 or V ₊ , f = 1 MHz | Room | | 8 | | pF |
| | C _{COM(off)} | | Room | | 14 | | |
| Channel-On Capacitance ^d | C _{NO/NC(on)} | | Room | | 28 | | |
| | C _{COM(on)} | | Room | | 28 | | |
| Power Supply | | | | | | | |
| Power Supply Current | I ₊ | V _{IN} = 0 or V ₊ | Room Full | | 0.001 | 1.0 1.0 | μA |

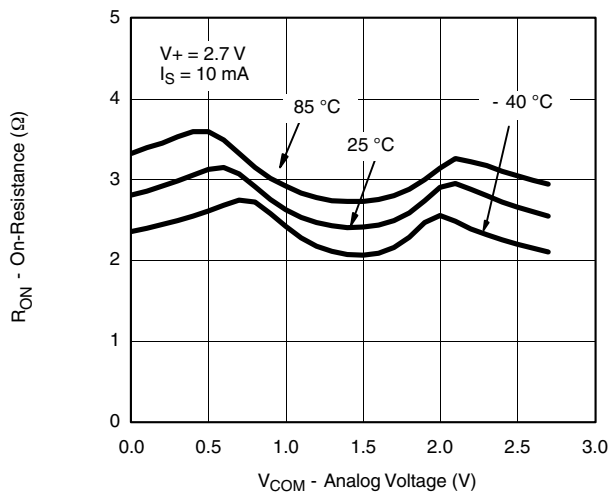
Notes:

- a. Room = 25 °C, Full = as determined by the operating suffix.
- b. Typical values are for design aid only, not guaranteed nor subject to production testing.
- c. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- d. Guarantee by design, nor subjected to production test.
- e. V_{IN} = input voltage to perform proper function.
- f. Guaranteed by 5 V leakage testing, not production tested.

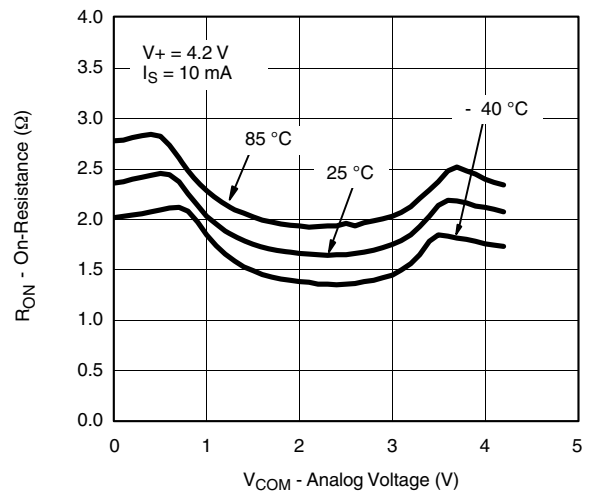
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



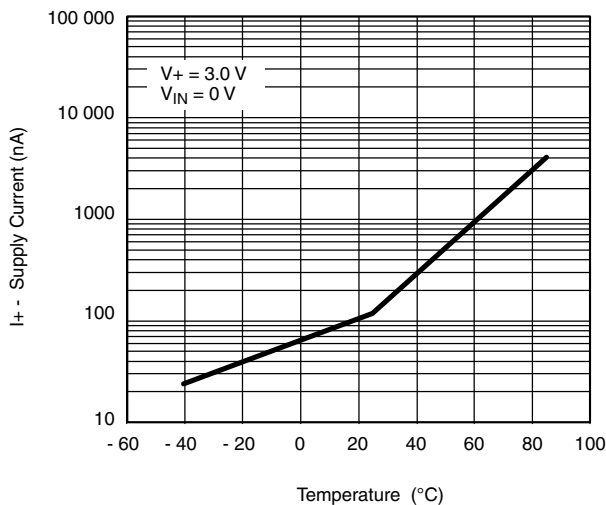
RON vs. VCOM and Supply Voltage



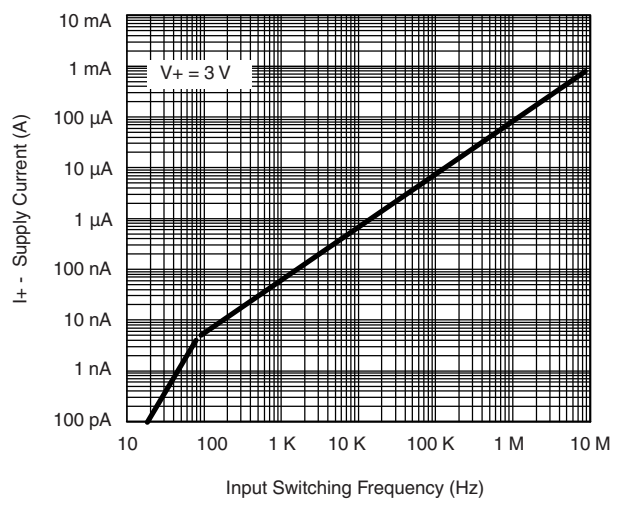
RON vs. Analog Voltage and Temperature



RON vs. Analog Voltage and Temperature

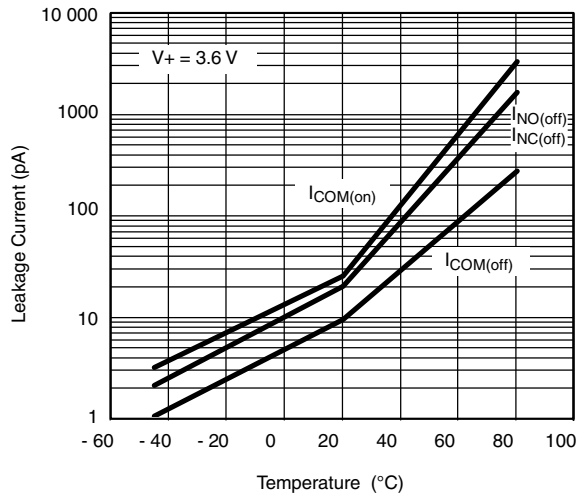


Supply Current vs. Temperature

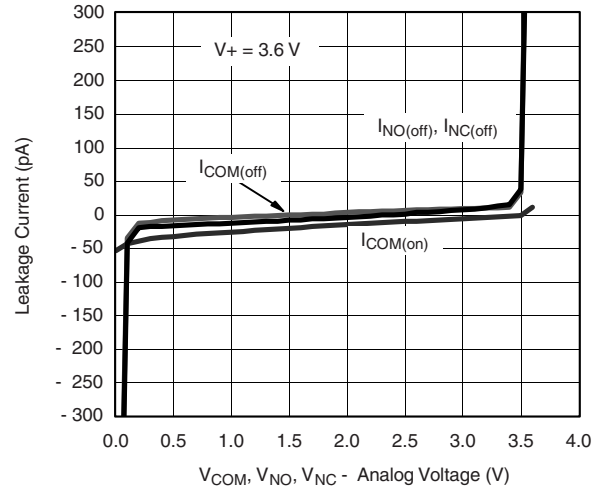


Supply Current vs. Input Switching Frequency

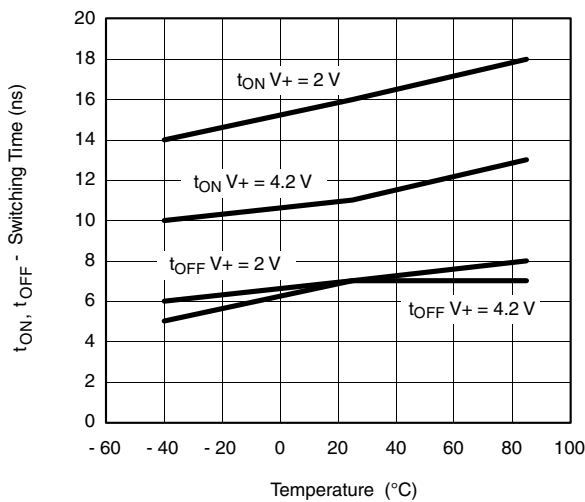
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



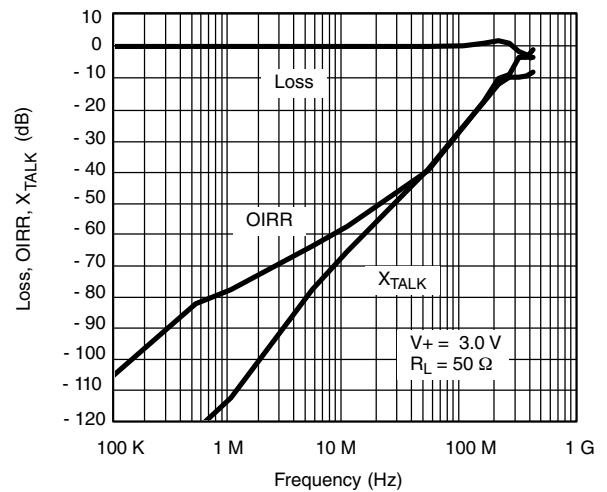
Leakage Current vs. Temperature



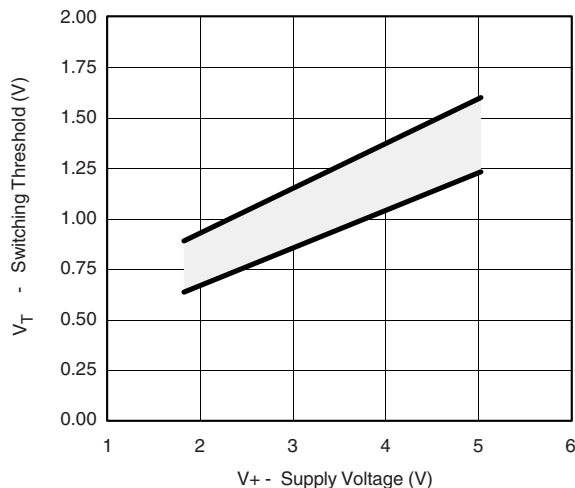
Leakage vs. Analog Voltage



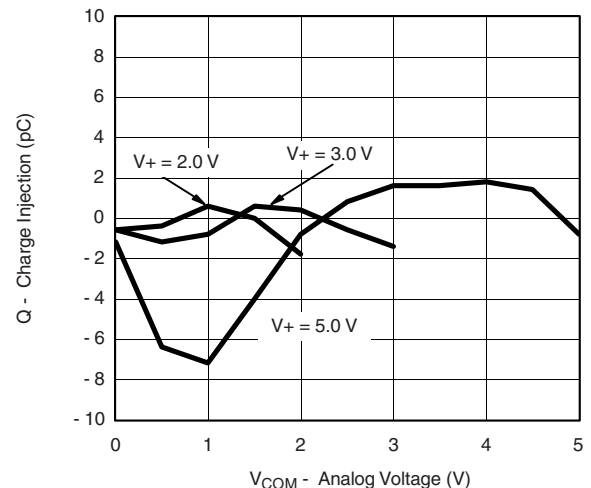
Switching Time vs. Temperature



Insertion Loss, Off-Isolation, Crosstalk vs. Frequency

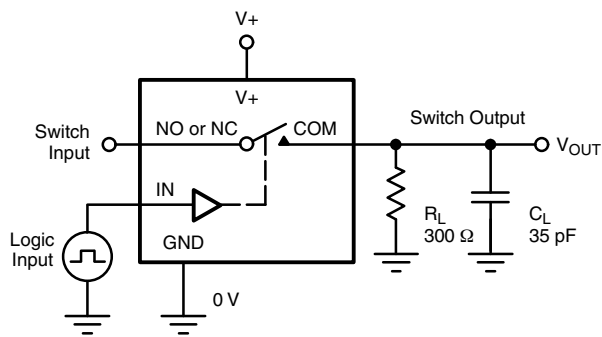


Switching Threshold vs. Supply Voltage



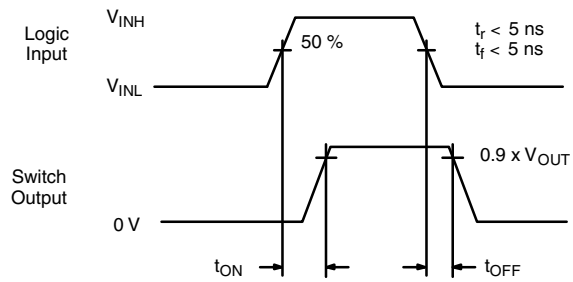
Charge Injection vs. Analog Voltage

TEST CIRCUITS



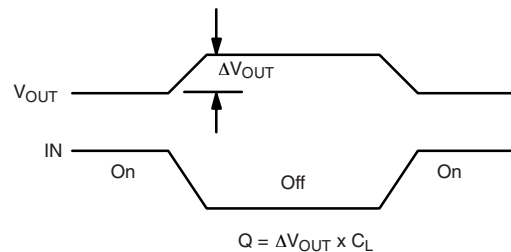
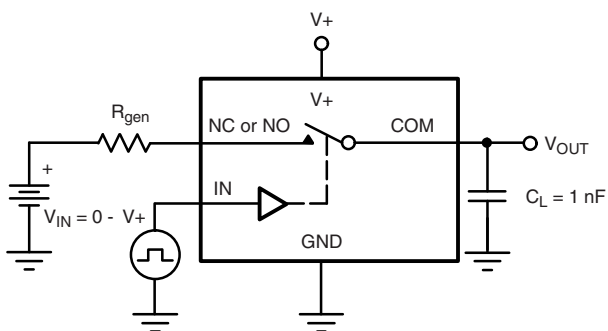
C_L (includes fixture and stray capacitance)

$$V_{OUT} = V_{NOorNC} \left(\frac{R_L}{R_L + R_{ON}} \right)$$



Logic "1" = Switch On
Logic input waveforms inverted for switches that have the opposite logic sense.

Figure 1. Switching Time



IN depends on switch configuration: input polarity determined by sense of switch.

Figure 2. Charge Injection

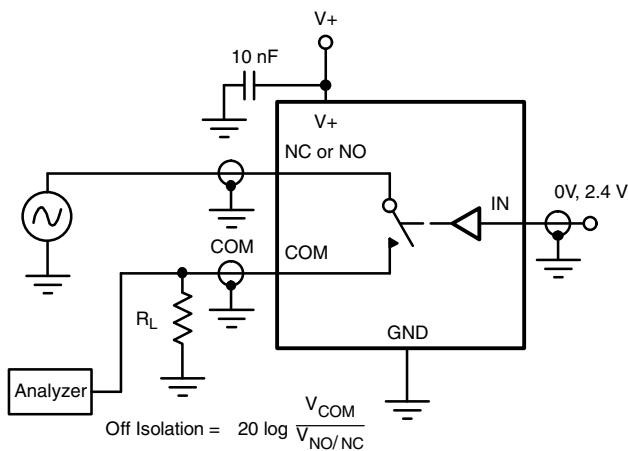


Figure 3. Off-Isolation

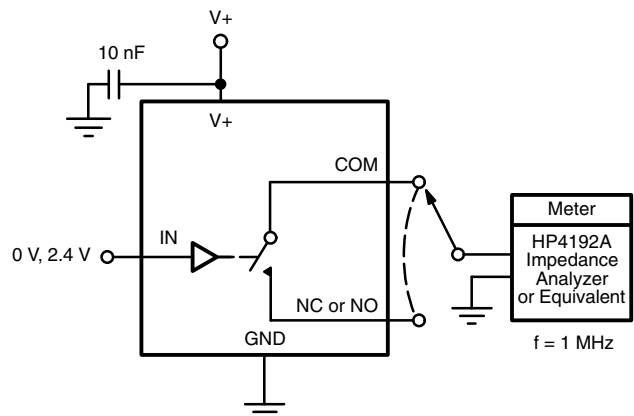
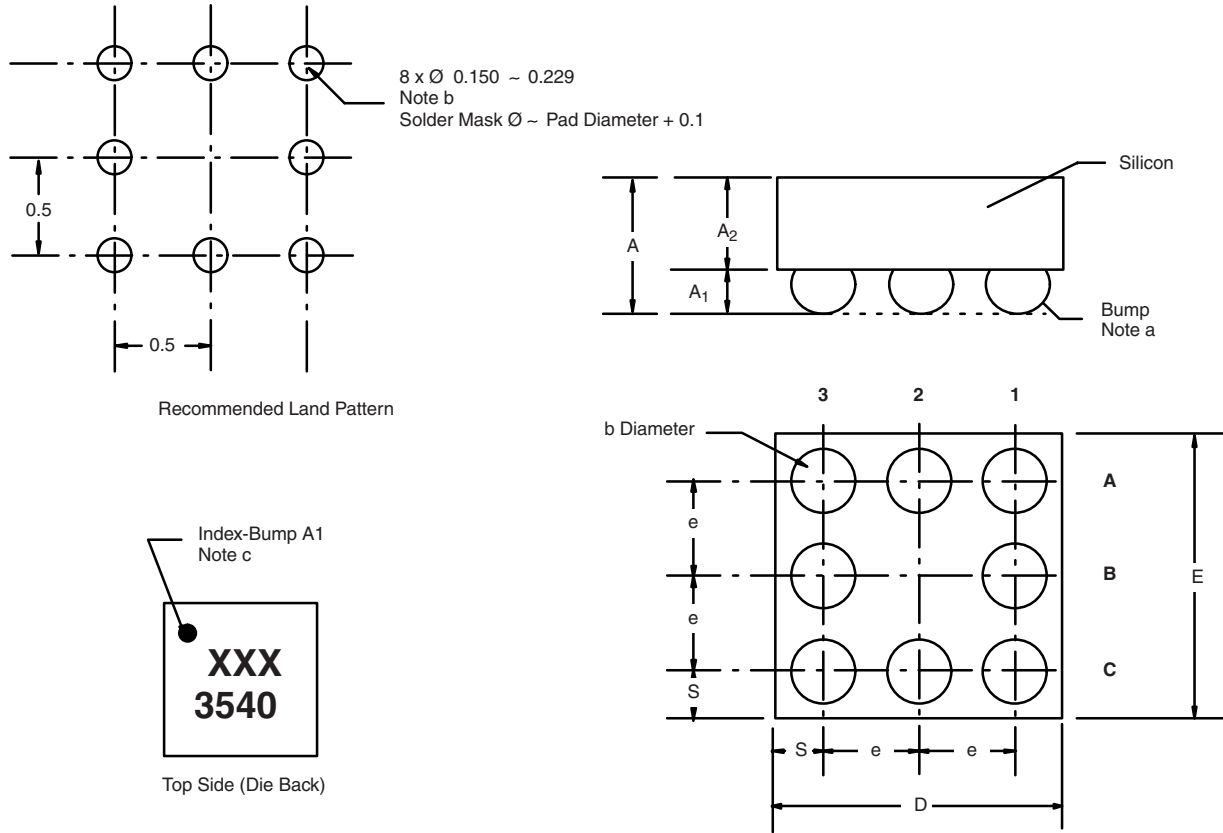


Figure 4. Channel Off/On Capacitance

PACKAGE OUTLINE

MICRO FOOT: 8 BUMP (3 x 3, 0.5 mm PITCH, 0.238 mm BUMP HEIGHT)



Notes (Unless Otherwise Specified):

- a. Bump is Lead (Pb)-free Sn/Ag/Cu.
- b. Non-solder mask defined copper landing pad.
- c. Laser Mark on silicon die back; back-lapped, no coating. Shown is not actual marking; sample only.

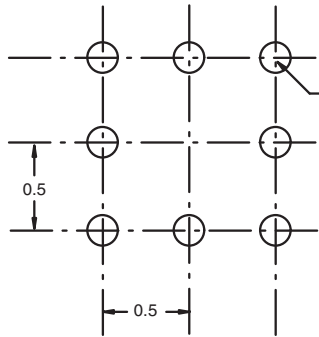
| Dim. | Millimeters ^a | | Inches | |
|----------------|--------------------------|-------|--------------|--------|
| | Min. | Max. | Min. | Max. |
| A | 0.688 | 0.753 | 0.0271 | 0.0296 |
| A ₁ | 0.218 | 0.258 | 0.0086 | 0.0102 |
| A ₂ | 0.470 | 0.495 | 0.0185 | 0.0195 |
| b | 0.306 | 0.346 | 0.0120 | 0.0136 |
| D | 1.480 | 1.520 | 0.0583 | 0.0598 |
| E | 1.480 | 1.520 | 0.0583 | 0.0598 |
| e | 0.5 BASIC | | 0.0197 BASIC | |
| S | 0.230 | 0.270 | 0.0091 | 0.0106 |

Notes:

- a. Use millimeters as the primary measurement.

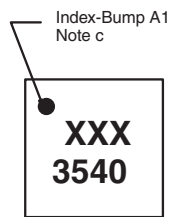
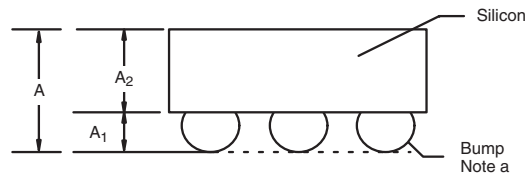
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MICRO FOOT: 8-BUMP (3 mm x 3 mm, 0.5 mm PITCH, 0.238 mm BUMP HEIGHT)

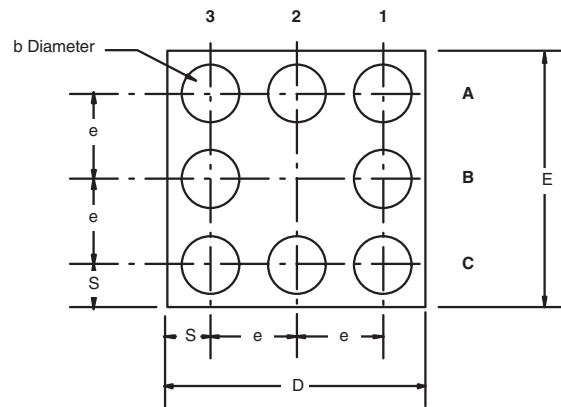


Recommended Land Pattern

8 x \varnothing 0.150 \square 0.229
 Note b
 Solder Mask \varnothing \square Pad Diameter + 0.1



Top Side (Die Back)



Notes

(unless otherwise specified)

- a. Bump is lead (Pb)-free Sn/Ag/Cu.
- b. Non-solder mask defined copper landing pad.
- c. Laser mark on silicon die back; back-lapped, no coating. Shown is not actual marking; sample only.

| DIM. | MILLIMETERS ^a | | INCHES | |
|----------------|--------------------------|-------|--------------|--------|
| | MIN. | MAX. | MIN. | MAX. |
| A | 0.688 | 0.753 | 0.0271 | 0.0296 |
| A ₁ | 0.218 | 0.258 | 0.0086 | 0.0102 |
| A ₂ | 0.470 | 0.495 | 0.0185 | 0.0195 |
| b | 0.306 | 0.346 | 0.0120 | 0.0136 |
| D | 1.480 | 1.520 | 0.0583 | 0.0598 |
| E | 1.480 | 1.520 | 0.0583 | 0.0598 |
| e | 0.5 BASIC | | 0.0197 BASIC | |
| S | 0.230 | 0.270 | 0.0091 | 0.0106 |

Note

- a. Use millimeters as the primary measurement.

ECN: S11-1065-Rev. A, 13-Jun-11
 DWG: 6002



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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

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Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management